

ULYS 1.10SP

Storage server with 2nd Gen Intel® Xeon® Scalable Processors



DESIGN PRINCIPLES

- I/O options for accelerated computing.
- Increased efficiency, accelerated performance.
- High-end storage server.
- Tool-less and lockable 2.5" drive trays.



TOP APPLICATIONS





Easy maintenance

KEY BENEFITS

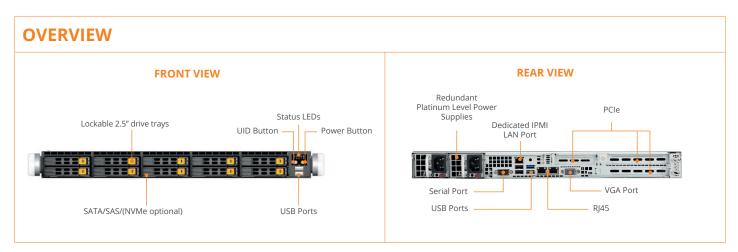
- Compact and powerful
- Simple to specify

KEY FEATURES

Unique solution which supports :

- 2nd Gen. Intel[®] Xeon[®] Scalable Processors
- Dual Socket P (LGA3647)
- Dual LAN Ethernet

- Up to 3TB 3DS ECC RDIMM/LRDIMM, DDR4-2933MHz, in 12 DIMM slots
- Aspeed[®] AST2500 remote management controller



2CRSi

Specifications are subject to change. Please verify with sales representative for latest revision.

ULYS 1.10SP



SPECIFICATIONS

System		Front I/O	
Model	ULYS 1.10SP	Button	1x Power 1x UID
Form Factor	10	LED	2x Network activity 1x Power status 1x HDD activity 1x System Overheat LED / Fan fail LED / UID LED
Dimension	597 x 437 x 43 23.5" x 17.2" x 1.7" (D x W x H)		
Sled			
Weight	15 kg 33 lbs	Port	2x USB
Storage		Back I/O	
Front type	10x hot-swap 2.5" SATA/SAS/ (NVMe optional)	Button	
Rear type	-	LED	1x UID
			4x USB 2x RJ45 Ethernet
Motherboard		Port	1x COM
CPU	2nd Gen Intel [®] Xeon [®] Scalable Processors and Intel [®] Xeon [®] Scalable Processors		1x VGA 1x IPMI
Chipset	Intel® C622	Internal connector	
Expansions slots	2x PCle 3.0 x16 (FH/HL) 1x PCle 3.0 x8 (LP)	Port	-
M.2 connector	1x M.2 PCle 3.0 x4	System Cooling	
Network	Up to 2x 10GbE base-T	Fans	4x fans (2 more can be added in option)
Processor		Power Input	:
Socket type	Dual Socket P (LGA3647)	Туре	700W/750W Redundant Power Supplies 80+ Platinum certified
Supported CPU	2nd Gen Intel [®] Xeon [®] Scalable Processors and Intel [®] Xeon [®] Scalable Processors	Input Range	100 - 140Vac / 8 - 6A / 50 - 60Hz 200 - 240Vac / 4.5 - 3.8A / 50 - 60Hz
TDP	Up to 205W	input Kange	200 - 240Vdc / 4.5 - 3.8A (CCC Only)
Memory		DC Output	700W: +12V Max: 58A / +5V sb Max: 3A 750W: +12V Max: 62A / +5V sb Max: 3A
Quantity	12x DIMM slots	Operating Environnement	
Capacity	Up to 3TB 3DS ECC RDIMM/ LRDIMM, DDR4-2933MHz	RoHS	RoHS compliant
Speed	2933/2666/2400/2133MHz ECC DDR4 RDIMM, LRDIMM	Temperature	Operating temperature: 10°C to 35°C Non-operating temperature: -40°C to 60°C
Channels	12x channels per CPU	Humidity	Operating humidity : 8-90% (non-condensing Non-operating humidity : 5-95%
Server manage	ement		(non-condensing)
ВМС	IPMI 2.0 with KVM support		
Chipset	Aspeed [®] AST2500		
ТРМ	TPM Header for SPI interface		

2CRSi

Specifications are subject to change. Please verify with sales representative for latest revision.